PCN Number:	201	20181102001.		0	PCN Date:		November 05, 2018			
Title: Datasheet for OPA1692										
Customer Contact:	<u>PCN</u>	Manage	<u>er</u>				I	Dej	pt:	Quality Services
Change Type:										
Assembly Site				Design						r Bump Site
Assembly Process							Wafer Bump Material			
Assembly Materials		=	Part number change				Wafer Bump Process			
Mechanical Specification			Щ	Test Site				Wafer Fab Site		
Packing/Shipping/Labeling		Ш	Test Process			Ļ	_	Wafer Fab Materials		
			NI.			N = 1 = 11 =			ware	r Fab Process
Notification Details										
Description of Change:										
Texas Instruments Incorporated is announcing an information only notification.										
The product datasheet(s) is being updated as summarized below. The following change history provides further details.										
TEXAS OPA1692										
INSTRUMENTS OPA1692 SBOS566C – JUNE 2017 – REVISED OCTOBER 2018										
Changes from Revision B (September 2018) to Revision C Page										
- Changed -40°C to 125°C lq to 975 μA										
The datasheet number will be changing.										
Device Family			, <u>s</u>	, -		Change From:				Change To:
OPA1692						SBOS566B				SBOS566C
These changes may be reviewed at the datasheet links provided.										
· ·										
http://www.ti.com/product/OPA1692										
Reason for Change:										
To accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Changes to product identification resulting from this PCN:										
None.										
Product Affected:										
OPA1692ID	OF	A1692I	DG	KR	1692IDGI	GKT			DPA1692IDR	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com